

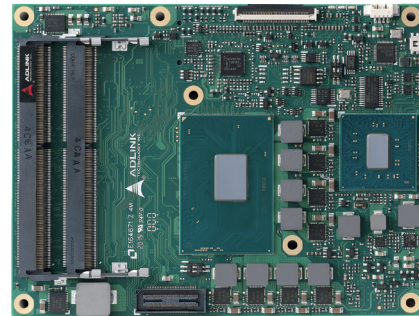
# Express-SL/SLE

COM Express Basic Size Type 6 Module with 6th Gen Intel® Core™, Intel® Xeon® and Celeron® Processor

## Features

- 6th Gen Intel® Core™, Intel® Xeon® and Celeron® Processor
- Up to 32 GB Dual Channel DDR4 at 1867/2133 MHz (supports both ECC and non-ECC memory)
- 3x DDI channels, 1x LVDS (or 4 lanes eDP) supports up to 3 independent displays
- 8x PCIe x1 (Gen3) and 1x PCIe x16 (Gen3)
- GbE, 4x SATA 6 Gb/s, 4x USB 3.0 and 4x USB 2.0
- Supports Smart Embedded Management Agent (SEMA®) functions
- Extreme Rugged operating temperature: -40°C to +85°C (build option)

New



## Specifications

### Core System

#### CPU

Mobile Intel® Xeon®, Core™ and Celeron® Processors - 14nm  
 Xeon® E3-1515M v5 2.8/3.7GHz (Turbo), 45W (4C/GT4e)  
 Xeon® E3-1505M v5 2.8/3.7GHz (Turbo), 45W (4C/GT2)  
 Xeon® E3-1505L v5 2.0/2.8GHz (Turbo), 25W (4C/GT2)  
 Core™ i7-6820EQ 2.8/3.5GHz (Turbo), 45W (4C/GT2)  
 Core™ i7-6822EQ 2.0/2.8GHz (Turbo), 25W (4C/GT2)  
 Core™ i5-6440EQ 2.7/3.4GHz (Turbo), 45W (4C/GT2)  
 Core™ i5-6442EQ 1.9/2.7GHz (Turbo), 25W (4C/GT2)  
 Core™ i3-6100E 2.7GHz (no Turbo), 35W (2C/GT2)  
 Core™ i3-6102E 1.9GHz (no Turbo), 25W (2C/GT2)  
 Celeron® G3900E 2.4GHz (no Turbo), 35W (2C/GT1)  
 Supports: Intel® VT, Intel® TXT, Intel® SSE4.2, Intel® HT Technology, Intel® 64 Architecture, Execute Disable Bit, Intel® Turbo Boost Technology 2.0, Intel® AVX2, Intel® AES-NI, PCLMULQDQ Instruction, Intel® Secure Key and Intel® TSX.  
 Note: Availability of the features may vary between processor SKUs.

#### Memory

Dual channel 1867/2133 MHz DDR4 memory up to 32GB in dual SODIMM sockets (ECC/non-ECC support dependent on selected CPU/PCH)

#### Embedded BIOS

AMI EFI with CMOS backup in 16MB SPI BIOS with Intel® AMT 11.0 support

#### Cache

8MB for Xeon® and Core™ i7, 6MB for Core™ i5, 3MB for Core™ i3, 2MB for Celeron®

#### PCH

CM236 (supports ECC memory, Intel® AMT)  
 QM170 (supports non-ECC, Intel® AMT)  
 HM170 (supports non-ECC, no Intel® AMT support)

#### Expansion Busses

PCIe x16 or 2 PCIe x8 or 1 PCIe x8 with 2 PCIe x4 (Gen3)  
 6 PCI Express x1 (Gen3); AB connector, Lanes 0/1/2/3/4/5  
 2 PCI Express x2 (Gen3): CD connector, Lanes 6/7  
 LPC bus, SMBus (system), I<sup>2</sup>C (user)

### Debug Headers

40-pin flat cable connector for use with DB-40 debug module providing BIOS POST code LED, BMC access, SPI BIOS flashing, power testpoints, debug LEDs  
 60-pin XDP header for ICE debug of CPU/chipset

### Video

#### GPU Feature Support

Intel® Generation 9 LP Graphics Core Architecture, supporting 3 independent and simultaneous display combinations of DisplayPort/HDMI/LVDS or eDP outputs

#### Hardware encode/transcode

HD content (including HEVC) DirectX 12, DirectX 11.2, DirectX 11.1, DirectX 11, DirectX 10.1, DirectX 10, DirectX 9 support OpenGL 4.4/4.3 and ES 2.0 support  
 OpenCL 2.1, 2.0/1.2 support

#### Digital Display Interface

DDI1/2/3 supporting DisplayPort/HDMI/DVI

#### LVDS

Single/dual channel 18/24-bit LVDS from eDP-to-LVDS IC

#### eDP

4 lane support optional, in place of LVDS

### Audio

#### Chipset

Intel® HD Audio integrated in chipset

#### Audio Codec

located on carrier Express-BASE6 (ALC886 standard supported)

### Ethernet

Intel® MAC/PHY: i219LM/V (LM with AMT 11.0 support)  
 Interface: 10/100/1000 GbE connection

Note: "build option" indicates an alternative BOM configuration to support additional or alternative functions that are not available on the standard product.  
 Be aware that these "build option" part numbers will need to be newly created and this will result in production lead times.

## Specifications

### • I/O Interfaces

USB: 4x USB v. 3.0 (USB 0,1,2,3) and 4x USB 2.0 (USB 4,5,6,7)  
SATA: Four ports SATA 6Gb/s (SATA0,1,2,3)  
Serial: 2 UART ports with console redirection  
GPIO: 4 GPO and 4 GPI

### • Super I/O

Supported on carrier if needed (standard support for W83627DHG-P)

### • TPM (option)

Chipset: Atmel AT97SC3204  
Type: TPM1.2/2.0 (TPM 2.0 support with project basis)

### • Power

Standard Input: ATX = 12V±5% / 5Vsb ±5% or AT = 12V±5%  
Wide Input: ATX = 8.5-20 V / 5Vsb ±5% or AT = 8.5 ~20V (Standard temp. only)  
Management: ACPI 5.0 compliant, Smart Battery support  
Power States: C1-C6, S0, S1, S3, S4, S5, S5 ECO mode (Wake-on-USB S3/S4, WOL S3/S4/S5)  
ECO mode: Supports deep S5 mode for power saving

### • Operating Systems

#### Standard Support

Windows 10/8.1 64-bit, Windows 7 32/64-bit, Linux 64-bit, VxWorks

#### Extended Support (BSP)

WES 7 32/64-bit, Linux 64-bit, VxWorks

### • Mechanical and Environmental

Form Factor: PICMG COM.0, Rev 2.1 Type 6  
Dimension: Basic size, 125 mm x 95 mm

#### Operating Temperature

Standard: 0°C to 60°C  
Extreme Rugged: -40°C to +85°C (build option for Core™ & Celeron® 25W TDP SKUs)

#### Humidity

5-90% RH operating, non-condensing  
5-95% RH storage (and operating with conformal coating)

#### Shock and Vibration

IEC 60068-2-64 and IEC-60068-2-27  
MIL-STD-202F, Method 213B, Table 213-I, Condition A and Method 214A, Table 214-I, Condition D

#### HALT

Thermal Stress, Vibration Stress, Thermal Shock and Combined Test

### • Intelligent Middleware

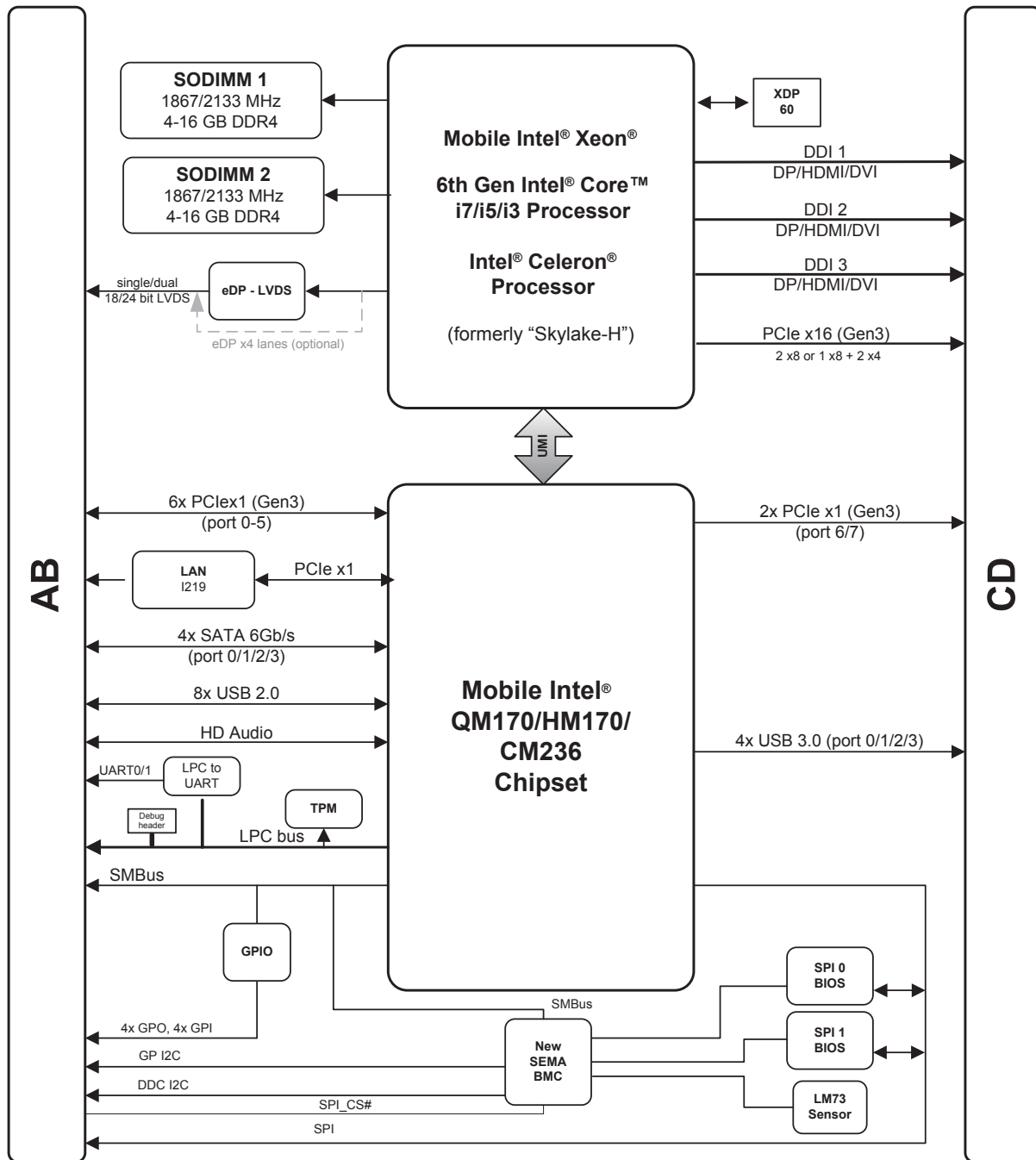
#### SEMA®

Local management, control of embedded computer systems  
Extended EAPI for monitoring, controlling and analytics applications  
Multiple OS support and across platforms (x86, ARM)



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## Functional Diagram



## Ordering Information

- **Express-SLE-E3-1515M v5**  
Basic COM Express Type 6 module with Intel® Xeon® E3-1515M v5 and GT4e level graphics, CM236 chipset, support ECC
- **Express-SLE-E3-1505M v5**  
Basic COM Express Type 6 module with Intel® Xeon® E3-1505M v5 and GT2 level graphics, CM236 chipset, support ECC
- **Express-SLE-E3-1505L v5**  
Basic COM Express Type 6 module with Intel® Xeon® E3-1505L v5 and GT2 level graphics, CM236 chipset, support ECC
- **Express-SL-i7-6820EQ**  
Basic COM Express Type 6 module with Intel® Core™ i7-6820EQ and GT2 level graphics, QM170 chipset
- **Express-SL-i7-6822EQ**  
Basic COM Express Type 6 module with Intel® Core™ i7-6822EQ, and GT2 level graphics, QM170 chipset
- **Express-SL-i5-6440EQ**  
Basic COM Express Type 6 module with Intel® Core™ i5-6440EQ and GT2 level graphics, QM170 chipset
- **Express-SL-i5-6442EQ**  
Basic COM Express Type 6 module with Intel® Core™ i5-6442EQ and GT2 level graphics, QM170 chipset
- **Express-SL-i3-6100E**  
Basic COM Express Type 6 module with Intel® Core™ i3-6100E and GT2 level graphics, HM170 chipset
- **Express-SL-i3-6102E**  
Basic COM Express Type 6 module with Intel® Core™ i3-6102E and GT2 level graphics, HM170 chipset
- **Express-SL-G3900E**  
Basic COM Express Type 6 module with Intel® Celeron® G3900E and GT1 level graphics, HM170 chipset

## Accessories

### Heat Spreaders

- **HTS-SL-B**  
Heatspreader for Express-SL with threaded standoffs for bottom mounting
- **HTS-SL-BT**  
Heatspreader for Express-SL with through hole standoffs for top mounting

### Passive Heatsinks

- **THS-SL-BL**  
Low profile heatsink for Express-SL with threaded standoffs for bottom mounting
- **THS-SL-BT**  
Low profile heatsink for Express-SL with through hole standoffs for top mounting
- **TSHS-SL-BL**  
High profile heatsink for Express-SL with threaded standoffs for bottom mounting

### Active Heatsink

- **THSF-SL-BL**  
High profile heatsink with fan for Express-SL with threaded standoffs for bottom mounting
- **THSF-SLE-GT4e-BL**  
High profile heatsink with fan for Express-SL-E3-1515M v5 with threaded standoffs for bottom mounting

## Starter Kit

- **Starterkit-COM Express 6 PLUS**  
COM Express formfactor starter kit with Express-BASE6 board, power supply, and accessory kit



Authorized Distributor

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